

AMPMODU | AMPMODU Headers

TE Internal #: 826947-3

PCB Mount Header, Right Angle, Board-to-Board, 3 Position, 2.54 mm [.1 in] Centerline, Breakaway, Tin, Through Hole - Solder,

Signal, AMPMODU Headers

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Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Right Angle
Connector System: Board-to-Board

Number of Positions: 3

Number of Rows: 1

Features

Product Type Features

PCB Connector Assembly Type	PCB Mount Header
Connector System	Board-to-Board
Header Type	Breakaway
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board

Configuration Features

Connector Contact Load Condition	Fully Loaded
PCB Mount Orientation	Right Angle
Number of Positions	3
Number of Rows	1
Board-to-Board Configuration	Perpendicular

Electrical Characteristics

Insulation Resistance	5000 ΜΩ	
Dielectric Withstanding Voltage (Max)	750 Vrms	

Body Features

Primary Product Color	Green	
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Contact Features



Contact Shape & Form Contact Underplating Material PCB Contact Termination Area Plating Material Tin Contact Base Material Phosphor Bronze Contact Mating Area Plating Material Tin Contact Mating Area Plating Material Tin Contact Mating Area Plating Material Tin Contact Type Pin Contact Current Rating (Max) 5 A Termination Features Square Termination Post & Tail Dimension Ad mml.025 in] Termination Post & Tail Length 3.2 mml.126 in] Termination Method to Printed Circuit Board Through Hole - Solder Mechanical Attachment Mating Alignment Without PCB Mount Retention Without PCB Mount Alignment Without Connector Mounting Type Board Mount Housing Features Centerline (Pitch) Housing Material PBT Dimensions
PCB Contact Termination Area Plating Material Contact Base Material Phosphor Bronze Contact Mating Area Plating Material Tin Contact Mating Area Plating Material Thickness 3 µm[118.11 µin] Contact Type Prin Contact Current Rating (Max) 5 A Termination Features Square Termination Post & Tail Dimension Fermination Post & Tail Length 3.2 mm[.025 in] Termination Method to Printed Circuit Board Through Hole - Solder Mechanical Attachment Mating Alignment Without PCB Mount Retention Without PCB Mount Alignment Without Connector Mounting Type Board Mount Housing Features Centerline (Pitch) 2.54 mm[.1 in] Housing Material
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Square Termination Post & Tail Dimension Termination Post & Tail Length 3.2 mm[.126 in] Termination Method to Printed Circuit Board Mechanical Attachment Mating Alignment PCB Mount Retention Without PCB Mount Alignment Without Connector Mounting Type Board Mount Housing Features Centerline (Pitch) Housing Material As mm[.025 in] Without Through Hole - Solder Without Without 2.54 mm[.1 in]
Termination Post & Tail Length Termination Method to Printed Circuit Board Through Hole - Solder Mechanical Attachment Mating Alignment Without PCB Mount Retention Without PCB Mount Alignment Without Connector Mounting Type Board Mount Housing Features Centerline (Pitch) PBT
Termination Method to Printed Circuit Board Mechanical Attachment Mating Alignment PCB Mount Retention Without PCB Mount Alignment Without Connector Mounting Type Board Mount Housing Features Centerline (Pitch) Housing Material Through Hole - Solder Without 2.54 mm[.1 in] PBT
Mechanical Attachment Mating Alignment Without PCB Mount Retention Without PCB Mount Alignment Without Connector Mounting Type Board Mount Housing Features Z.54 mm[.1 in] Housing Material PBT
Mating Alignment PCB Mount Retention Without PCB Mount Alignment Without Connector Mounting Type Board Mount Housing Features Centerline (Pitch) Augustian Street
PCB Mount Retention PCB Mount Alignment Connector Mounting Type Board Mount Housing Features Centerline (Pitch) Lossing Material PBT
PCB Mount Alignment Without Connector Mounting Type Board Mount Housing Features Centerline (Pitch) 2.54 mm[.1 in] Housing Material PBT
Connector Mounting Type Housing Features Centerline (Pitch) Housing Material PBT
Housing Features Centerline (Pitch) 2.54 mm[.1 in] Housing Material PBT
Centerline (Pitch) Housing Material 2.54 mm[.1 in] PBT
Housing Material PBT
Dimensions
PCB Thickness (Recommended) 1.57 mm[.062 in]
Usage Conditions
Housing Temperature Rating Standard
Operating Temperature Range -65 – 105 °C[-85 – 221 °F]
Operation/Application
Circuit Application Signal
Industry Standards
UL Flammability Rating UL 94V-0
Packaging Features
Packaging Quantity 1500



Packaging Type	Carton	

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2022 (224) Candidate List Declared Against: JAN 2021 (211) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 265°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts





Also in the Series | AMPMODU Headers





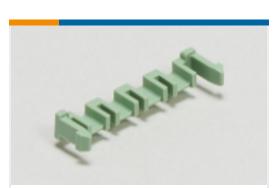




PCB Connector Shrouds(1)



PCB Headers & Receptacles(6830)



PCB Latches, Locks & Retainers(2)



Wire-to-Board Connector Assemblies & Housings(5)



Wire-to-Board Connector Contacts(66)

Documents

Product Drawings

03P MODU 2 PIN HDR

English

03P MODU 2 PIN HDR

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_826947-3_M.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_826947-3_M.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_826947-3_M.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Environmental Compliance

Product Compliance

English

Product Compliance

English

Agency Approvals

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UL Report

English